

- 8-Bit Parallel-Out Storage Register Performs Serial-to-Parallel Conversion with Storage
- Asynchronous Parallel Clear
- Active High Decoder
- Enable/Disable Input Simplified Expansion
- Expandable for N-Bit Applications
- Four District Functional Modes
- Package Options Include Ceramic Chip Carriers and Flat Packages in Addition to Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

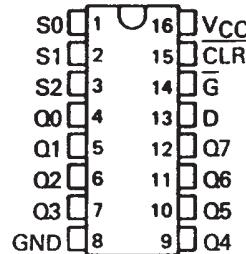
These 8-bit addressable latches are designed for general purpose storage applications in digital systems. Specific uses include working registers, serial-holding registers, and active-high decoders or demultiplexers. They are multifunctional devices capable of storing single-line data in eight addressable latches, and being a 1-of-8 decoder or demultiplexer with active-high outputs.

Four distinct modes of operation are selectable by controlling the clear (CLR) and enable (G) inputs as enumerated in the function table. In the addressable-latch mode, data at the data-in terminal is written into the addressed latch. The addressed latch will follow the data input with all unaddressed latches remaining in their previous states. In the memory mode, all latches remain in their previous states and are unaffected by the data or address inputs. To eliminate the possibility of entering erroneous data in the latches, enable G should be held high (inactive) while the address lines are changing. In the 1-of-8 decoding or demultiplexing mode, the addressed output will follow the level of the D input with all other outputs low. In the clear mode, all outputs are low and unaffected by the address and data inputs.

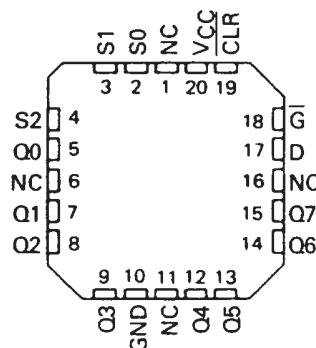
The SN54259 and SN54LS259B are characterized for operation over the full military temperature range of -55°C to 125°C . The SN74259 and SN74LS259B are characterized for operation from 0°C to 70°C .

SN54259, SN54LS259B . . . J OR W PACKAGE
SN74259 . . . N PACKAGE
SN74LS259B . . . D OR N PACKAGE

(TOP VIEW)

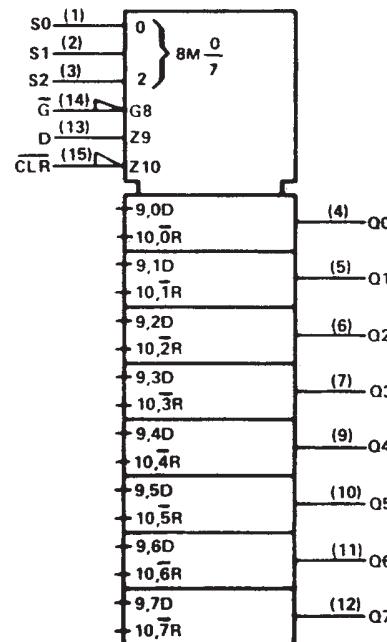


SN54LS259B . . . FK PACKAGE
(TOP VIEW)



NC - No internal connection

logic symbol[†]



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN54259, SN54LS259B, SN74259, SN74LS259B 8-BIT ADDRESSABLE LATCHES

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FUNCTION TABLE

INPUTS	OUTPUT OF ADDRESSED LATCH	EACH OTHER OUTPUT	FUNCTION
CLR	G		
H	L	D	Q_{i0} Addressable Latch
H	H	Q_{i0}	Q_{i0} Memory
L	L	D	8-Line Demultiplexer
L	H	L	Clear

H ≡ high level, L ≡ low level

D ≡ the level at the data input

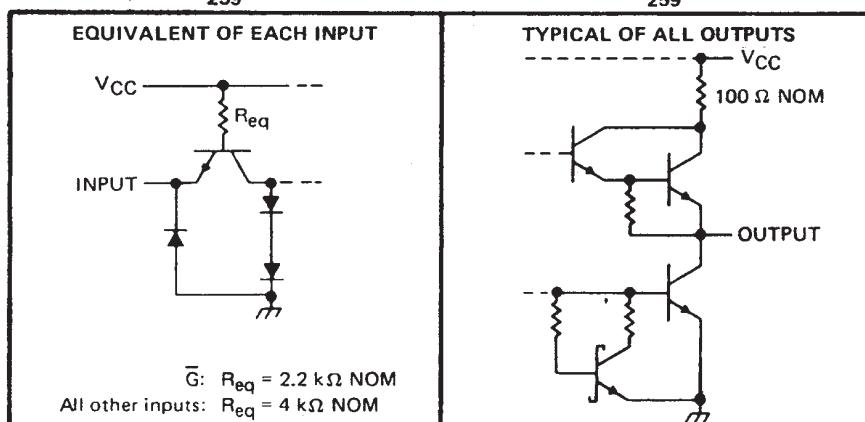
Q_{i0} ≡ the level of Q_i ($i = 0, 1, \dots, 7$, as appropriate) before the indicated steady-state input conditions were established.

LATCH SELECTION TABLE

SELECT INPUTS	LATCH ADDRESSED		
S2	S1	S0	
L	L	L	0
L	L	H	1
L	H	L	2
L	H	H	3
H	L	L	4
H	L	H	5
H	H	L	6
H	H	H	7

schematic of inputs and outputs

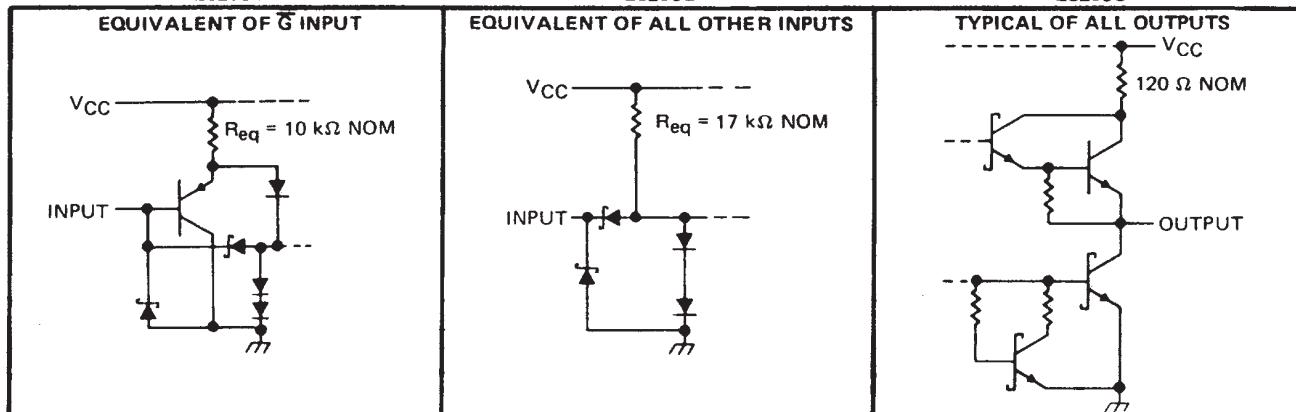
'259



'LS259B

'LS259B

'LS259B



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage (see Note 1)	7 V
Input voltage: SN54259, SN74259	5.5 V
SN54LS259B, SN74LS259B	7 V
Operating free-air temperature range: SN54259, SN54LS259B	-55°C to 125°C
SN74259, SN74LS259B	0°C to 70°C
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	Data	SN54259			SN74259			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				-800			-800	μA
Low-level output current, I_{OL}				16			16	mA
Width of clear or enable pulse, t_W				15			15	ns
Setup time, t_{SU}	Data			15↑			15↑	ns
	Address			5↑			5↑	
Hold time, t_h	Data			0↑			0↑	ns
	Address			20↑			20↑	
Operating free-air temperature, T_A		-55		125	0		70	°C

†The arrow indicates that the rising edge of the enable pulse is used for reference.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	SN54259			SN74259			UNIT
		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH} High-level input voltage		2			2			V
V_{IL} Low-level input voltage				0.8			0.8	V
V_{IK} Input clamp voltage	$V_{CC} = \text{MIN}$, $I_I = 12 \text{ mA}$			-1.5			-1.5	V
V_{OH} High-level output voltage	$V_{CC} = \text{MIN}$, $V_{IH} = 2 \text{ V}$, $V_{IL} = 0.8 \text{ V}$, $I_{OH} = -800 \mu A$	2.4	3.4		2.4	3.4		V
V_{OL} Low-level output voltage	$V_{CC} = \text{MIN}$, $V_{IH} = 2 \text{ V}$, $V_{IL} = 0.8 \text{ V}$, $I_{OL} = 16 \text{ mA}$		0.2	0.4		0.2	0.4	V
I_I Input current at maximum input voltage	$V_{CC} = \text{MAX}$, $V_I = 5.5 \text{ V}$			1			1	mA
I_{IH} High-level input current	\bar{G}			80			80	μA
	Other inputs			40			40	
I_{IL} Low-level input current	\bar{G}			-3.2			-3.2	mA
	Other inputs			-1.6			-1.6	
I_{OS} Short-circuit output current§	$V_{CC} = \text{MAX}$		-18	-57	-18	-57		mA
I_{CC} Supply current	$V_{CC} = \text{MAX}$, See Note 2		60	90		60	90	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$.

§ Not more than one output should be shorted at a time.

NOTE 2: I_{CC} is measured with the inputs grounded and the outputs open.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PHL}	CLR	Any Q	$C_L = 15 \text{ pF}$, $R_L = 400 \Omega$, See Note 3	16	25		ns
t_{PLH}	Data	Any Q		14	24		ns
t_{PHL}		Any Q		11	20		
t_{PLH}	Address	Any Q		15	28		ns
t_{PHL}		Any Q		17	28		
t_{PLH}	\bar{G}	Any Q		12	20		ns
t_{PHL}		Any Q		11	20		

t_{PLH} = propagation delay time, low-to-high-level output

t_{PHL} = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

SN54LS259B, SN74LS259B 8-BIT ADDRESSABLE LATCHES

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recommended operating conditions

		SN54LS259B			SN74LS259B			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.7			0.8	V
I _{OH}	High-level output current			-0.4			-0.4	mA
I _{OL}	Low-level output current			4			8	mA
t _W	Pulse duration	̄G low		17		17		ns
		CLR low		10		10		
t _{SU}	Set up time	Data before ̄G ↑		20		20		ns
		Address before ̄G ↑		17		17		
		Address before ̄G ↓		0		0		
t _H	Hold time	Data after ̄G ↑		0		0		ns
		Address after ̄G ↑		0		0		
T _A	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	SN54LS259B			SN74LS259B			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA			-1.5			-1.5	V
V _{OH}	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX, I _{OH} = -0.4 mA	2.5	3.4		2.7	3.4		V
V _{OL}	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX	I _{OL} = 4 mA	0.25	0.4	0.25	0.4		V
		I _{OL} = 8 mA			0.35	0.5		
I _I	V _{CC} = MAX, V _I = 7 V			0.1			0.1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			20			20	μA
I _{IL}	V _{CC} = MAX, V _I = 0.4 V			-0.4			-0.4	mA
I _{OS} [§]	V _{CC} = MAX	-20	-100		-20	-100		mA
I _{CC}	V _{CC} = MAX, See Note 2	27	36		22	36		mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions

[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§] Not more than one output should be shorted at a time, and duration short-circuit should not exceed one second.

NOTE 2: I_{CC} is measured with the inputs grounded and the outputs open.

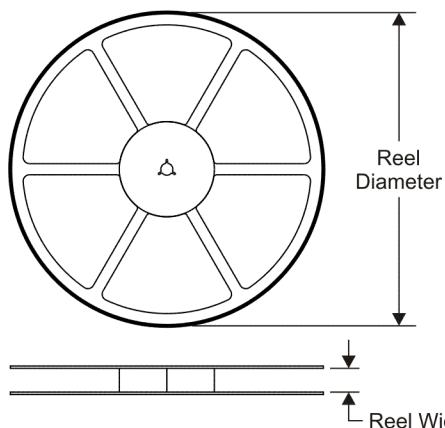
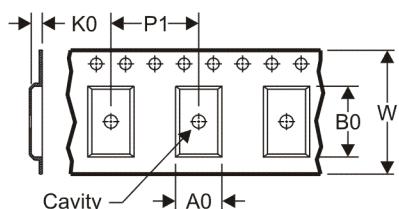
switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{PHL}	CLR	Any Q	C _L = 15 pF, R _L = 2 kΩ, See Note 3	12	18		ns
t _{PLH}	Data	Any Q		19	30		
t _{PHL}		Any Q		13	20		ns
t _{PLH}	Address	Any Q		17	27		ns
t _{PHL}		Any Q		14	20		
t _{PLH}	̄G	Any Q		15	24		ns
t _{PHL}		Any Q		15	24		

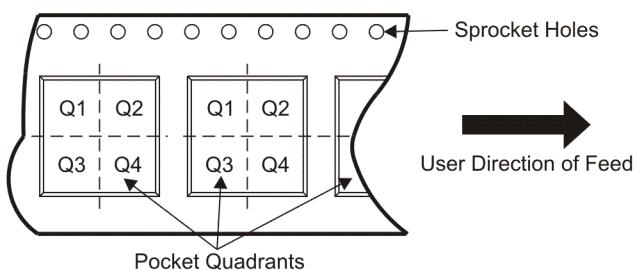
t_{PLH} = propagation delay time, low-to-high-level output

t_{PHL} = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

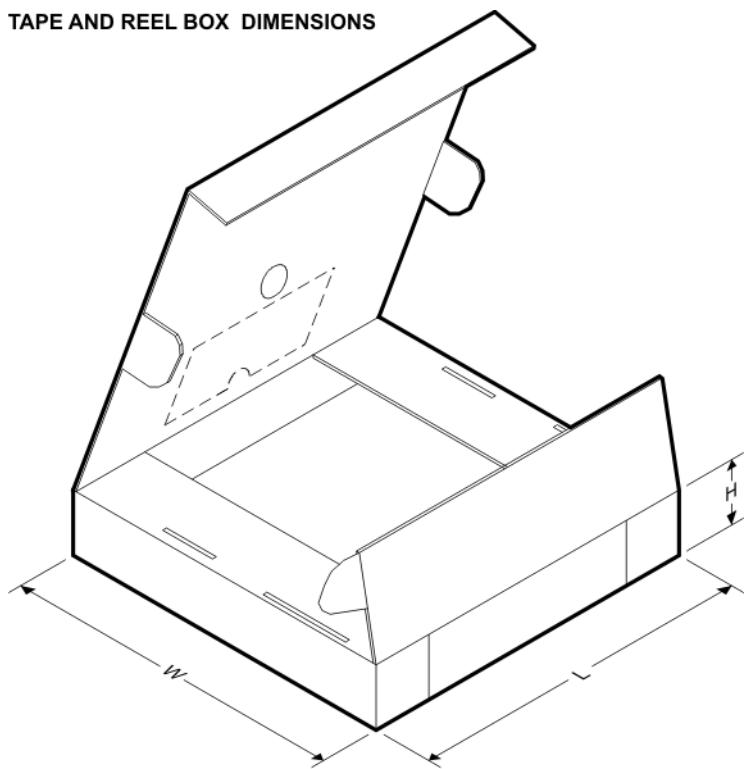
TAPE AND REEL INFORMATION
REEL DIMENSIONS

TAPE DIMENSIONS


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS259BDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS259BDR	SOIC	D	16	2500	333.2	345.9	28.6

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